

Silicon Carbide Diode

Rev.01 - 13 August 2021

Product data sheet

1. General description

Dual Silicon Carbide Schottky diode in a 3-lead TO247 plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- · Extremely fast reverse recovery time
- Low figure of merit (Q_C*V_F)
- Highly stable switching performance
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
 - Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

uick reference data						
Parameter	Conditions		Values			Unit
maximum rating						
repetitive peak reverse voltage		1200			V	
limiting average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 105 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>		40		A	
junction temperature			1	75		°C
Parameter	Conditions		Min	Тур	Max	Unit
aracteristics	·					
forward voltage	$I_F = 20 \text{ A}; T_j = 25 \text{ °C}; \text{ per diode}; \text{Fig. 5}$		-	1.5	1.8	V
	I_{F} = 20 A; T_{j} = 150 °C; per diode; Fig. 5		-	2.1	2.5	V
	I_{F} = 20 A; T_{j} = 175 °C; per diode; Fig. 5		-	2.25	2.8	V
characteristics						
recovered charge	$I_F = 20 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; \text{ V}_R = 400 \text{ V};$ $T_J = 25 \text{ °C}; \text{ per diode}; \text{ Fig. 7}$		-	39	-	nC
	Parameter maximum rating repetitive peak reverse voltage limiting average forward current junction temperature Parameter aracteristics forward voltage characteristics	ParameterConditionsmaximum ratingrepetitive peak reverse voltage $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105 ^{\circ}C$; both diodes conducting; Fig. 1; Fig. 2; Fig. 3limiting average forward current $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105 ^{\circ}C$; both diodes conducting; Fig. 1; Fig. 2; Fig. 3junction temperatureParameterParameterConditionsaracteristicsIF = 20 A; T_J = 25 ^{\circ}C; per diode; Fig. 5IF = 20 A; T_J = 150 ^{\circ}C; per diode; Fig. 5IF = 20 A; T_J = 175 ^{\circ}C; per diode; Fig. 5characteristicsrecovered chargeIF = 20 A; dIF/dt = 500 A/µs; VR = 400 V;	ParameterConditionsmaximum ratingrepetitive peak reverse voltage $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105 \text{ °C}$; both diodes conducting; Fig. 1; Fig. 2; Fig. 3limiting average forward current $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105 \text{ °C}$; both diodes conducting; Fig. 1; Fig. 2; Fig. 3junction temperatureParameterParameterConditionsaracteristicsIF = 20 A; T_J = 25 °C; per diode; Fig. 5forward voltageIF = 20 A; T_J = 150 °C; per diode; Fig. 5IF = 20 A; T_J = 175 °C; per diode; Fig. 5characteristicsrecovered chargeIF = 20 A; dIF/dt = 500 A/µs; VR = 400 V;	ParameterConditionsValmaximum ratingImage: Second conditionsValrepetitive peak reverse voltage $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105$ °C; both diodes conducting; Fig. 1; Fig. 2; Fig. 3Image: Second conducting; Fig. 1; Fig. 2; Fig. 3junction temperature $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105$ °C; both diodes conducting; Fig. 1; Fig. 2; Fig. 3Image: Second conducting; Fig. 1; Fig. 2; Fig. 3ParameterConditionsMinaracteristicsIf = 20 A; T_1 = 25 °C; per diode; Fig. 5-forward voltageIf = 20 A; T_1 = 150 °C; per diode; Fig. 5-If = 20 A; T_1 = 175 °C; per diode; Fig. 5If = 20 A; T_1 = 175 °C; per diode; Fig. 5characteristicsIf = 20 A; dl = 175 °C; per diode; Fig. 5-recovered chargeIf = 20 A; dl = 500 A/µs; V_R = 400 V;-	ParameterConditionsValuesmaximum ratingrepetitive peak reverse voltage1200limiting average forward current $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105$ °C; both diodes conducting; Fig. 1; Fig. 2; Fig. 340junction temperature 775 ParameterConditionsMinTyparacteristics $I_F = 20 \text{ A}; T_j = 25 ^{\circ}C; \text{ per diode; Fig. 5}$ -1.5 $I_F = 20 \text{ A}; T_j = 150 ^{\circ}C; \text{ per diode; Fig. 5}$ -2.1 $I_F = 20 \text{ A}; T_j = 175 ^{\circ}C; \text{ per diode; Fig. 5}$ -2.25characteristicsrecovered charge $I_F = 20 \text{ A}; dI_F/dt = 500 \text{ A}/\mus; V_R = 400 \text{ V};$ -39	ParameterConditionsValuesmaximum ratingrepetitive peak reverse voltage1200repetitive peak reverse voltage $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105$ °C; both diodes conducting; Fig. 2; Fig. 340limiting average forward current $\delta = 0.5$; square-wave pulse; $T_{mb} \le 105$ °C; both diodes conducting; Fig. 2; Fig. 340junction temperatureConditionsMinTypMaxParameterConditionsMinTypMaxaracteristicsIF = 20 A; Tj = 25 °C; per diode; Fig. 5-1.51.8IF = 20 A; Tj = 150 °C; per diode; Fig. 5-2.12.5IF = 20 A; Tj = 175 °C; per diode; Fig. 5-2.252.8characteristicsrecovered chargeIF = 20 A; dIF/dt = 500 A/µs; VR = 400 V;-39-

5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	A1	anode						
2	К	cathode						
3	A2	anode		K				
mb	mb	mounting base; connected to cathode		sym125				

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC2D401200CW	TO247	WNSC2D401200CWQ	Tube	30	SOT429	25-Mar-2013		

7. Marking

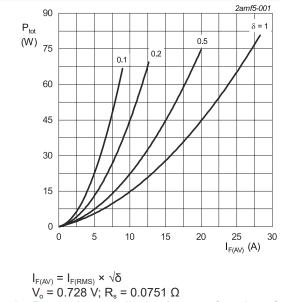
Table 4. Marking codes						
Type number	Marking codes					
WNSC2D401200CW	WNSC2D 401200CW					

8. Limiting values

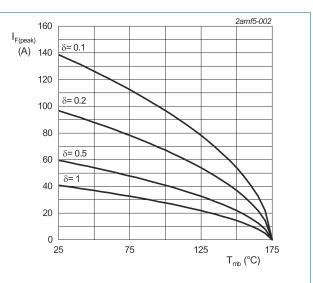
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		1200	V
V_{RWM}	crest working reverse voltage		1200	V
V _R	reverse voltage	DC	1200	V
I _{O(AV)}	limiting average forward current	$δ = 0.5$; square-wave pulse; $T_{mb} \le 105$ °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	40	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 103 °C; square-wave pulse; per diode	40	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	125	A
		t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse; per diode	1150	A
l ² t	l ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	78	A ² s
T _{stg}	storage temperature		-55 to 175	°C
Tj	junction temperature		175	°C



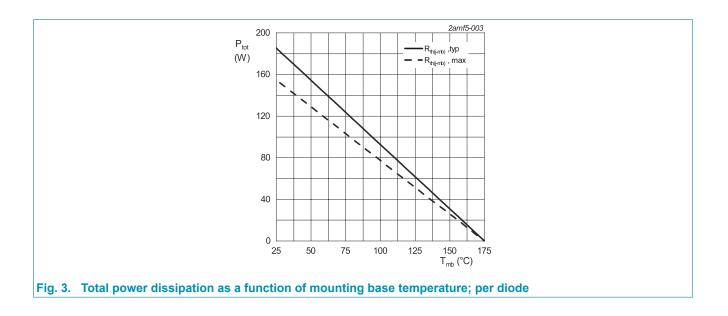
V_o = 0.728 V; R_s = 0.0751 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode





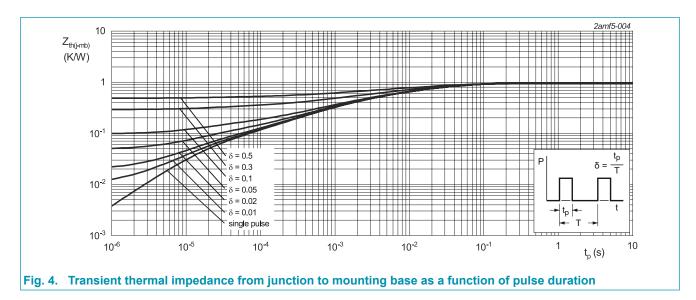
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WNSC2D401200CW Silicon Carbide Diode



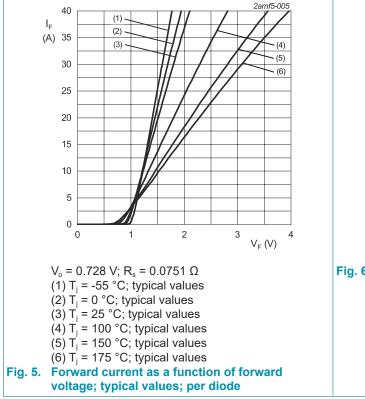
9. Thermal characteristics

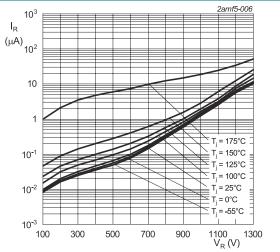
Table 6. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
$R_{\text{th(j-mb)}}$	thermal resistance	per diode; <u>Fig. 4</u>		-	0.81	0.97	K/W	
	from junction to mounting base	both diodes conducting		-	-	0.47	K/W	
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W	



10. Characteristics

Table 7. Cl	naracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$V_{\rm F}$	forward current	I _F = 20 A; T _j = 25 °C; per diode; <u>Fig. 5</u>	-	1.5	1.8	V
		$I_{F} = 20 \text{ A}; T_{j} = 150 \text{ °C}; \text{ per diode}; Fig. 5$	-	2.1	2.5	V
		$I_F = 20 \text{ A}; T_j = 175 \text{ °C}; \text{ per diode}; Fig. 5$	-	2.25	2.8	V
I _R	reverse current	V_{R} = 1200 V; T _j = 25 °C; per diode; <u>Fig. 6</u>	-	8	200	μA
		V _R = 1200 V; T _j = 175 °C; per diode; <u>Fig. 6</u>	-	90		μA
Dynamic	characteristics	· · · · ·				
Q _r	recovered charge	$I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ per diode}; Fig. 7$	-	39	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	845	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C	-	79	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C	-	58	-	pF
E _{as}	non-repetitive avalanche energy	I_R = 5.3 A; L = 10 mH; $T_{j(init)}$ = 25 °C; per diode	140	-	-	mJ

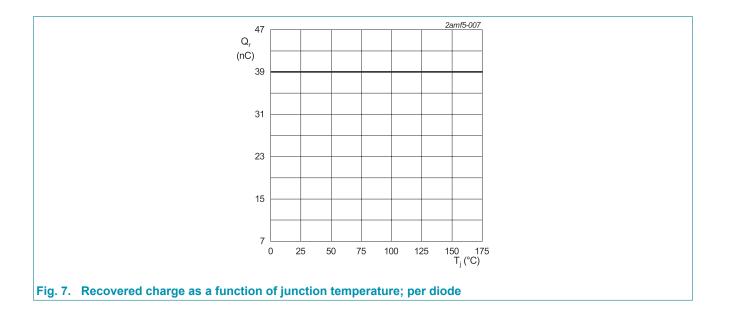






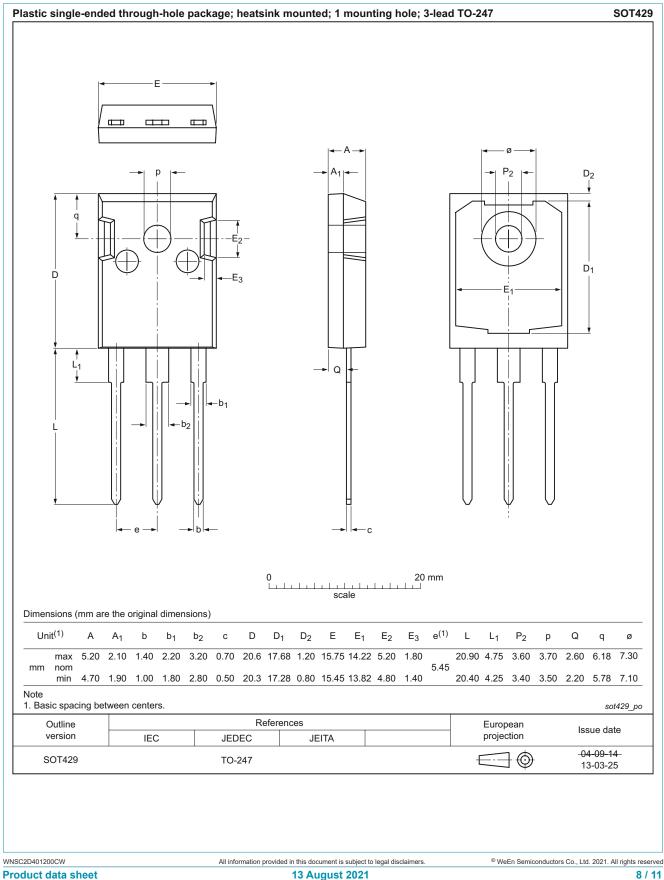
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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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